

MCC

Micro Commercial Components
21201 Itasca Street Chatsworth
CA 91311
Phone: (818) 701-4933
Fax: (818) 701-4939

SS22 THRU SS210

Features

- Schottky Barrier Rectifier
- Guard Ring Protection
- Low Forward Voltage
- Reverse Energy Tested
- High Current Capability
- Extremely Low Thermal Resistance

Maximum Ratings

- Operating Temperature: -55°C to +125°C
- Storage Temperature: -55°C to +150°C
- Maximum Thermal Resistance; 15°C/W Junction To Lead

| MCC Catalog Number | Device Marking | Maximum Recurrent Peak Reverse Voltage | Maximum RMS Voltage | Maximum DC Blocking Voltage |
|--------------------|----------------|--|---------------------|-----------------------------|
| SS22 | SS22 | 20V | 14V | 20V |
| SS23 | SS23 | 30V | 21V | 30V |
| SS24 | SS24 | 40V | 28V | 40V |
| SS25 | SS25 | 50V | 35V | 50V |
| SS26 | SS26 | 60V | 42V | 60V |
| SS28 | SS28 | 80V | 56V | 80V |
| SS210 | SS210 | 100V | 70V | 100V |

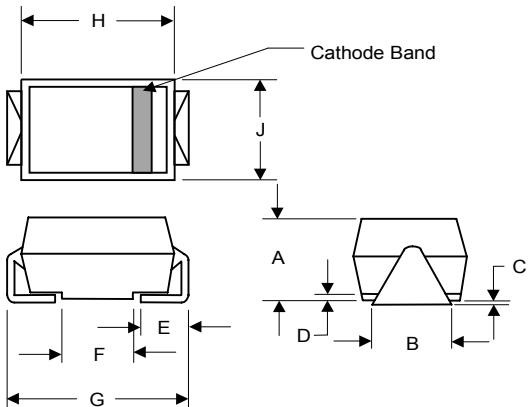
Electrical Characteristics @ 25°C Unless Otherwise Specified

| | | | |
|---|-------------|----------------------|--|
| Average Forward Current | $I_{F(AV)}$ | 2.0A | $T_J = 100^\circ C$ |
| Peak Forward Surge Current | I_{FSM} | 50A | 8.3ms, half sine |
| Maximum Instantaneous Forward Voltage SS22-SS24 SS25-SS26 SS28-SS210 | V_F | .55V .70V .85V | $I_{FM} = 2.0A;$ $T_J = 25^\circ C^*$ |
| Maximum DC Reverse Current At Rated DC Blocking Voltage | I_R | 0.5mA | $T_J = 25^\circ C$ |
| Typical Junction Capacitance SS22 SS23-SS210 | C_J | 230pF 50pF | Measured at 1.0MHz, $V_R=4.0V$ |

*Pulse test: Pulse width 300 μ sec, Duty cycle 2%

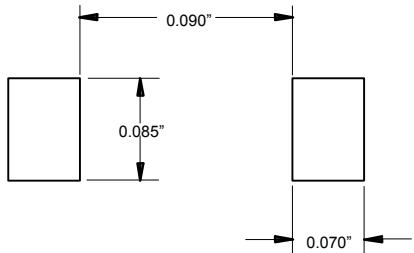
2 Amp Schottky Rectifier 20 to 100 Volts

DO-214AC (SMAJ) (High Profile)



| DIM | INCHES | | MM | | NOTE |
|-----|--------|------|------|------|------|
| | MIN | MAX | MIN | MAX | |
| A | .078 | .116 | 1.98 | 2.95 | |
| B | .067 | .089 | 1.70 | 2.25 | |
| C | .002 | .008 | .05 | .20 | |
| D | -- | .02 | -- | .51 | |
| E | .035 | .055 | .89 | 1.40 | |
| F | .065 | .096 | 1.65 | 2.45 | |
| G | .205 | .224 | 5.21 | 5.69 | |
| H | .160 | .180 | 4.06 | 4.57 | |
| J | .100 | .112 | 2.57 | 2.84 | |

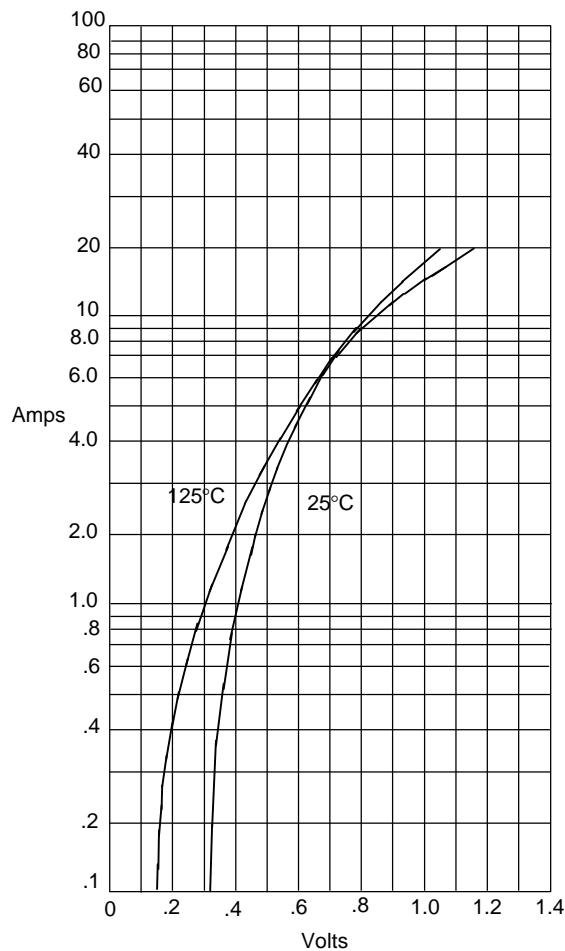
SUGGESTED SOLDER PAD LAYOUT



SS22

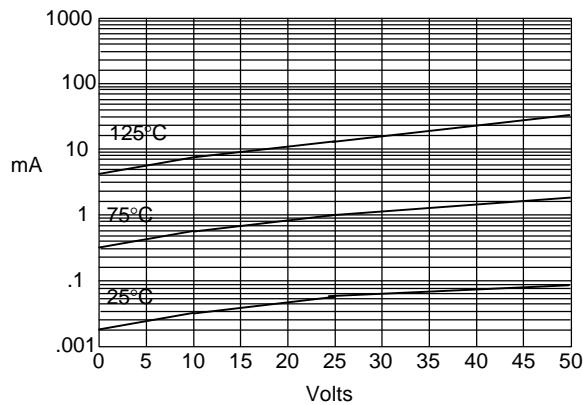
•M•C•C•

Figure 1
Typical Forward Characteristics



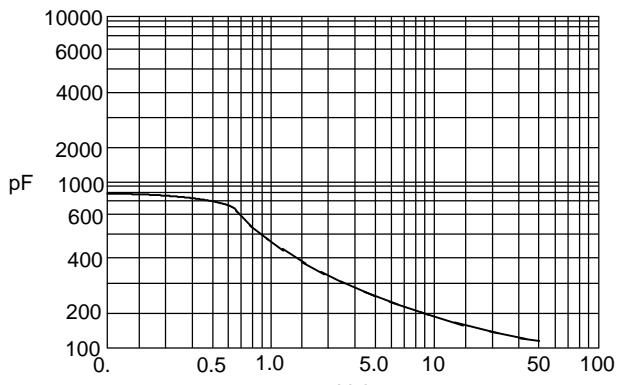
Instantaneous Forward Current - Ampèresversus
Instantaneous Forward Voltage - Volts

Figure 2
Typical Reverse Characteristics



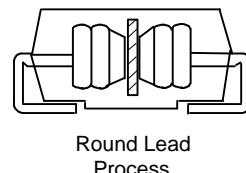
Typical Reverse Current - mAversus
Reverse Voltage - Volts

Figure 3
Typical Junction Capacitance



Junction Capacitance - pFversus
Reverse Voltage - Volts

Figure 4
New SMA Assembly

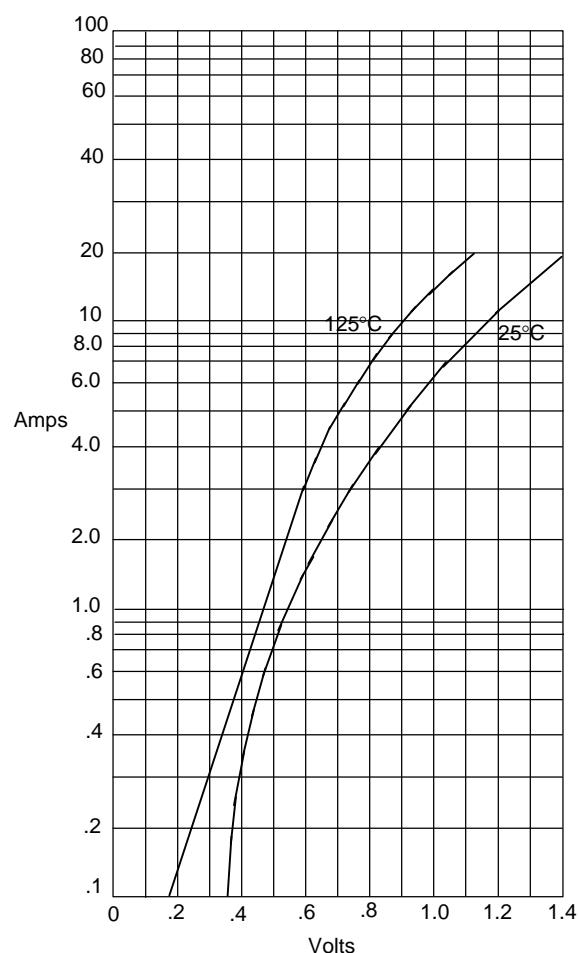


Round Lead
Process

SS23 thru SS210

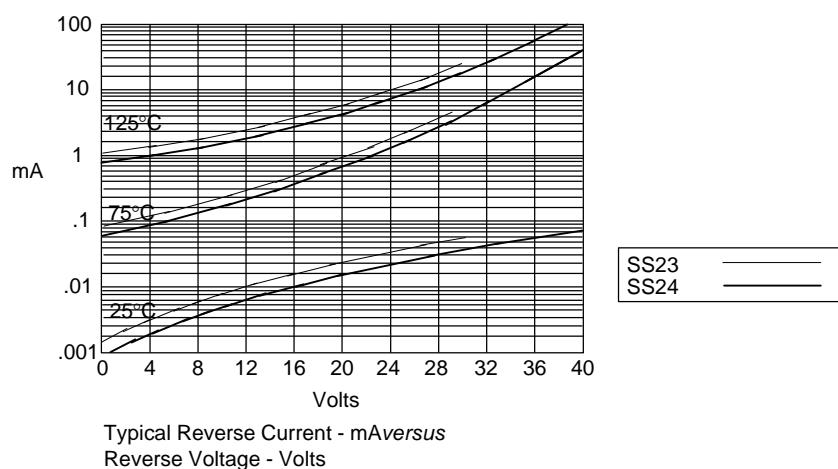
MCC

Figure 1
Typical Forward Characteristics



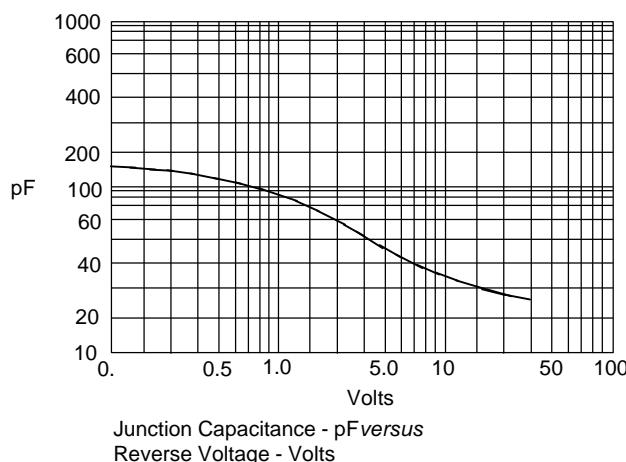
Instantaneous Forward Current - Amperes versus
Instantaneous Forward Voltage - Volts

Figure 2
Typical Reverse Characteristics



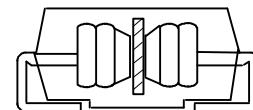
Typical Reverse Current - mA versus
Reverse Voltage - Volts

Figure 3
Typical Junction Capacitance



Junction Capacitance - pF versus
Reverse Voltage - Volts

Figure 4
New SMA Assembly



Round Lead
Process